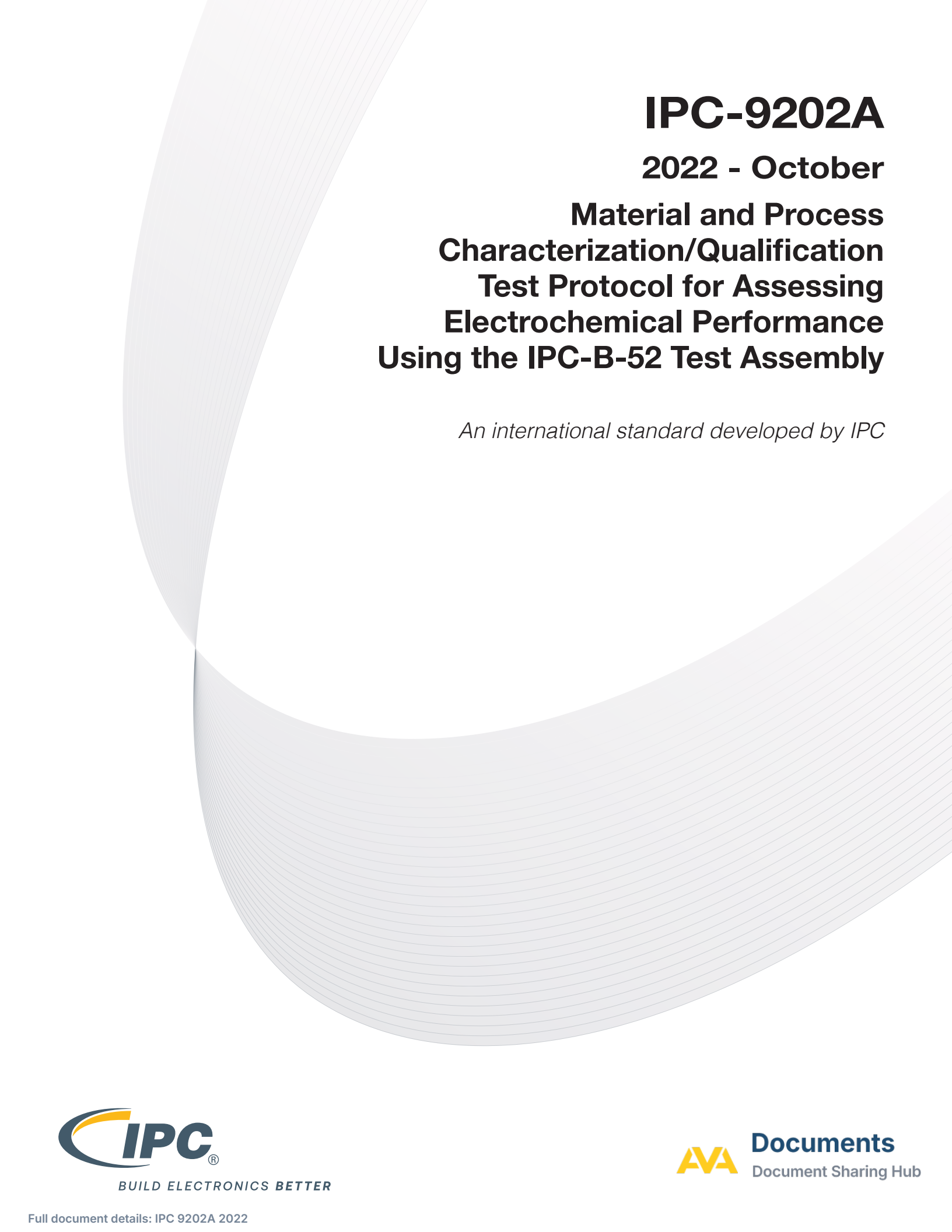




IPC-9202A

2022 - October

**Material and Process
Characterization/Qualification
Test Protocol for Assessing
Electrochemical Performance
Using the IPC-B-52 Test Assembly**

An international standard developed by IPC



BUILD ELECTRONICS BETTER



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Developed by the Residue Assessment Task Group (5-32g) of the
Cleaning and Coating Committee (5-30) of IPC

Supersedes:

IPC-9202 - October, 2011

Users of this publication are encouraged to
participate in the development of future revisions.

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Acknowledgment

Any document involving a complex technology draws material from a vast number of sources across many continents. While the principal members of the Residue Assessment Task Group (5-32g) of the Cleaning and Coating Committee (5-30) are shown below, it is not possible to include all of those who assisted in the evolution of this standard. To each of them, the members of the IPC extend their gratitude.

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Special Acknowledgment

Thank you to Joseph Rousseau (Precision Analytical Laboratory), David Lober (Kyzen Corporation), Graham Naisbitt (Gen3 Systems Limited), Keith Sellers (NTS Baltimore), Russell Shepherd (NTS Anaheim) and Phil Kinner (Electrolube) for your leadership and support of the former 5-32a, 5-32b and 5-32c committees which were merged to create the 5-32g Residue Assessment Task Group.